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FDS6675 Single P-Channel, Logic Level, PowerTrench[™] MOSFET

General Description

This P-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for notebook computer applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- $\begin{array}{c|c} \bullet & -11 \text{ A, } -30 \text{ V. } \text{R}_{\text{DS(ON)}} = 0.014 \ \Omega \ @ \ \text{V}_{\text{GS}} = -10 \text{ V,} \\ \text{R}_{\text{DS(ON)}} = 0.020 \ \Omega \ @ \ \text{V}_{\text{GS}} = -4.5 \text{ V.} \end{array}$
- Low gate charge (30nC typical).
- High performance trench technology for extremely low R_{DS(ON)}.
- High power and current handling capability.

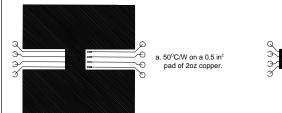
	. , 100				
SOT	-23 SuperSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16
Absolu	D D FDS SO-8 pin 1 S	s G s	5 6 7 8	- 4 - 3 - 2 - 1	
Symbol	Parameter			FDS6675	Units
V _{DSS}	Drain-Source Voltage	ge -30		V	
V _{GSS}	Gate-Source Voltage			V	
I _D	Drain Current - Continuous	(Note 1a)		-11	A
	- Pulsed			-50	
P _D	Power Dissipation for Single Operation	ation (Note 1a)		2.5	W
		(Note 1b)		1.2	

Symbol	Parameter	FDS6675	Units
V _{DSS}	Drain-Source Voltage	-30	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous (Note 1a)	-11	А
	- Pulsed	-50	
P _D	Power Dissipation for Single Operation (Note 1a)	2.5	W
	(Note 1b)	1.2	
	(Note 1c)	1	
T_J,T _{stg}	Operating and Storage Temperature Range	-55 to 150	°C
THERMA	L CHARACTERISTICS		
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)	50	°C/W
R _{ejc}	Thermal Resistance, Junction-to-Case (Note 1)	25	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I_{D} = -250 µA, Referenced t	to 25 °C		-22		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			T _J = 55°C			-10	μA
	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-1	-1.7	-3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	I_{D} = 250 µA, Referenced to	o 25 ℃		4.3		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -11 \text{ A}$			0.011	0.014	Ω
			T _J =125°C		0.016	0.023	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -9 \text{ A}$	•		0.015	0.02	
I _{D(ON)}	On-State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$		-50			А
9 _{FS}	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -11 \text{ A}$			32		S
DYNAMIC (CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			3000		pF
C _{oss}	Output Capacitance				870		pF
C _{rss}	Reverse Transfer Capacitance				360		pF
SWITCHING	CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	V _{DS} = -15 V, I _D = -1 A	$V_{DS} = -15 \text{ V}, \ I_{D} = -1 \text{ A}$		12	22	ns
t,	Turn - On Rise Time	V_{GEN} = -10 V, R_{GEN} = 6 Ω			16	27	ns
t _{D(off)}	Turn - Off Delay Time				50	80	ns
t,	Turn - Off Fall Time				100	140	ns
Q _g	Total Gate Charge	$V_{\rm DS} = -15 \text{ V}, \ \text{I}_{\rm D} = -11 \text{ A},$			30	42	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -5 V			9		nC
Q _{gd}	Gate-Drain Charge				11		nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS AND MAX	(IMUM RATINGS					
I _s	Maximum Continuous Drain-Source Diode Forward Current					-2.1	А
V _{SD}	Drain-Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_S = -2.1 \text{ A}$ (Note 2)				-0.72	-1.2	V

Notes:

1. R_{BW} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BW} is guaranteed by design while R_{BW} is determined by the user's board design.

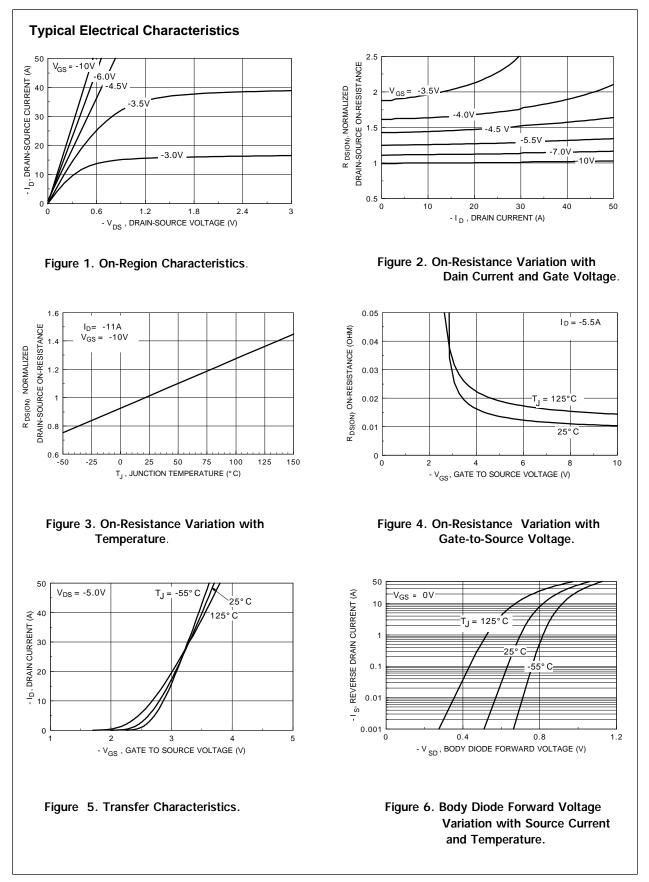




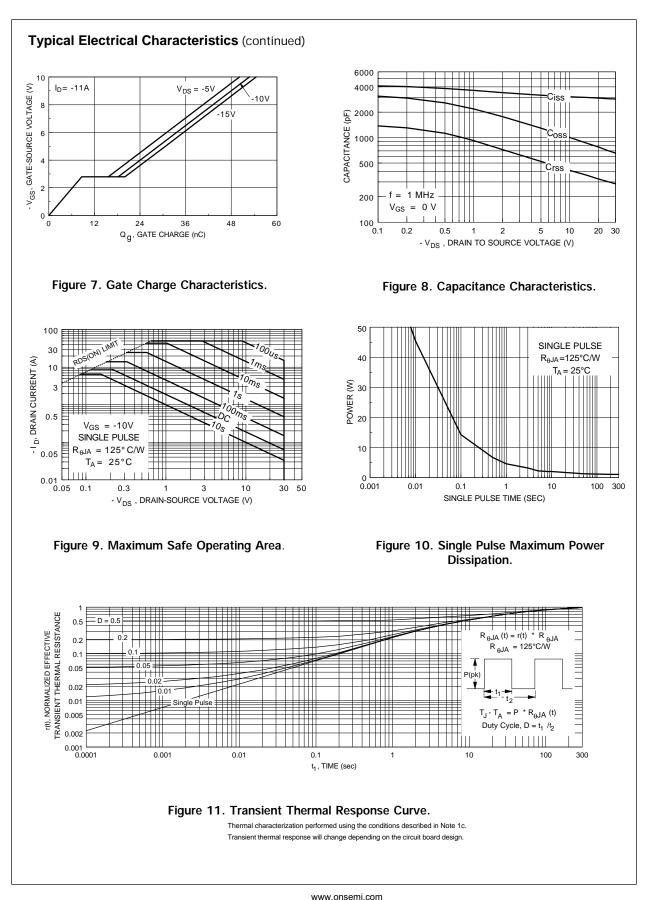
b. 105°C/W on a 0.02 in² pad of 2oz copper.

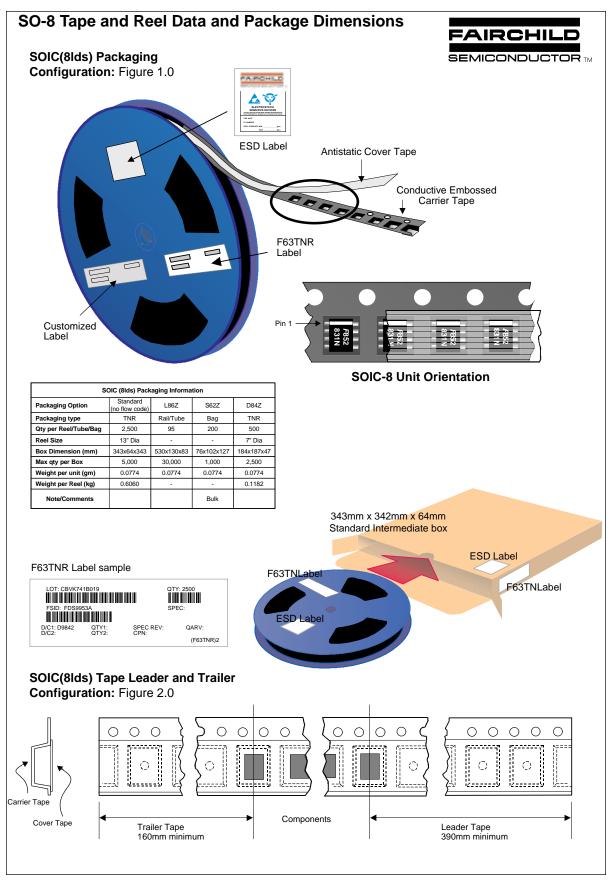
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width $\underline{<}$ 300 $\mu s,$ Duty Cycle $\underline{<}$ 2.0%.

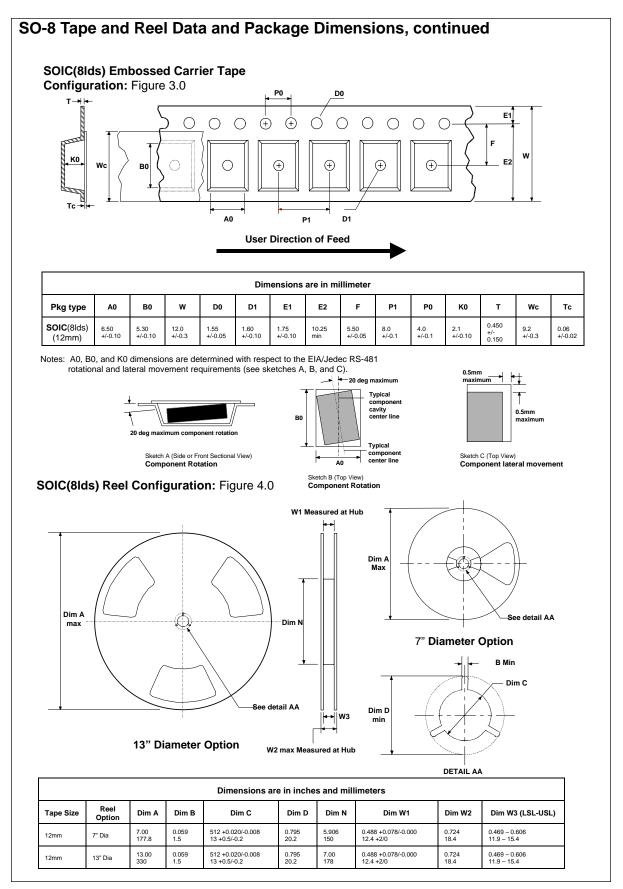


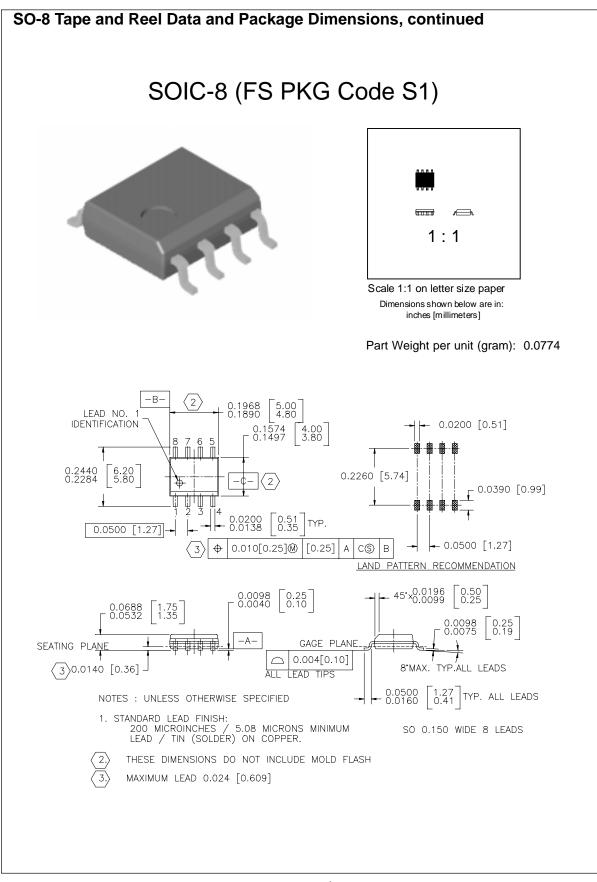
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